ASSOCIATION CONNECT	© Copyright 2005, IPC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						als and Mf	g Infor	mation		
Supplier Info	rmation															
Company name*		Company unique ID			τ	Unique ID Authority					Response Date*					
onsemi												2025-05-13				
Contact Name		Title - Contact			I	Phone - Contact*					Email - Contact*					
Product-Env-Ste	wards	Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com					
authorized Repro	esentative*	Title - Representative			1	Phone - Representative*				Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Reque	uester Item Number Mfr Iter		em Number Mfr Item Name				Effective Dat	te Versio	Version Ma		Manufacturing Site		eight*	* UC	OM	Unit Type
		NCS20071XV53T2G R2R		R2R Output Single 3 MHz Op Amp		Amp	2025-05-13 MY		MY1		2.	2.92 mg		5	Each	
<b>Ianufacturin</b>	g Proccess Informatio	n						<u> </u>								
Termin	Plating / Grid Array Material		Terminal Base Alloy		J-STD-020 MS	SL Rating	Peak Process Body Temperature		re Max Time at Peak Temper		Temperatu	nture Number of Reflow Cycles		es		
Precion Sn)	Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy		1		260		С		30 seco		s <b>3</b>			
Comments																
vel 1 - maximun	n time at peak temperature	during so	ldering is 10-3	0 seconds	<u> </u>	<u> </u>		<u> </u>								<u> </u>
or more informa	ation regarding material co	mposition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of						
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.05	mg	Supplier	Silicon (Si)	7440-21-3		0.05	mg
Die Attach Epoxy	0.06	mg		Epoxy resin	proprietary data		0.039	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.021	mg
Lead Frame	0.76	mg	Supplier	Zinc (Zn)	7440-66-6		0.0009	mg
			Supplier	Iron (Fe)	7439-89-6		0.0179	mg
			Supplier	Copper (Cu)	7440-50-8		0.741	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0002	mg
Mold Compound-Black	1.96	mg		Epoxy Phenol Resin	proprietary data		0.2058	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1.7542	mg
Plating	0.01	mg	Supplier	Palladium (Pd)	7440-05-3		0.0027	mg
			В	Nickel (Ni)	7440-02-0		0.0069	mg
			Supplier	Gold (Au)	7440-57-5		0.0004	mg
Wire Bond - Au	0.08	mg	Supplier	Gold (Au)	7440-57-5		0.08	mg